TECH DS8303 30V, 200mA Low Dropout Voltage Linear Regulator

General Description

The DS8303 series are a group of low-dropout (LDO) voltage regulators offering the benefits of wide input voltage range, low dropout voltage, low power consumption, and miniaturized packaging.

Quiescent current of only 2µA makes these devices ideal for powering the battery-powered, always-on systems that require very little idle-state power dissipation to a longer service life. There is an option of shutdown mode by selecting the parts with the EN pin and pulling it low. The shutdown current in this mode goes down to only 10nA (typical).

The DS8303 series of linear regulators are stable with the ceramic output capacitor over its wide input range from 2V to 30V and the entire range of output load current (0mA to 200mA).

Features

- 2µA Ground Current at no Load
- ±2% Output Accuracy
- 200mA Output Current
- 10nA Disable Current
- Wide Operating Input Voltage Range: 2V to 30V
- Dropout Voltage: 0.15V at 100mA / VOUT 5V
- Support Fixed Output Voltage 1.2V, 1.8V, 3.3V, 5V, 9V, 12V
- Stable with Ceramic or Tantalum Capacitor
- Current Limit Protection
- Over-Temperature Protection
- SOT-23-5, DFN-1x1-4L Package Available

Applications

- Portable, Battery Powered Equipment
- Low Power Microcontrollers
- Laptop, Palmtops and PDAs
- Wireless Communication Equipment
- Audio/Video Equipment
- Car Navigation Systems
- Industrial Controls
- Weighting Scales
- Meters
- Home Automation

Pin Configurations



DFN-1x1-4L





Ordering Information

DS8303-AABB

Designator	Description	Symbol	Description
AA		12	$V_{OUT} = 1.2V$
	Output Voltage		
		99	$V_{OUT} = 9.9V$
		A1	$V_{OUT} = 12V$
BB	Deskenstere	S5	SOT-23-5
	Package type	D4	 V _{OUT} = 9.9V V _{OUT} = 12V

Special Request: Any Voltage between 1.2V and 12V under specific business agreement

Description of Functional Pins

Pin No		Pin Name	Pin Function	
SOT-23-5	DFN-1x1-4L	FIII Name		
1	4	VIN	Input of Supply Voltage.	
2	2	GND	Ground	
3	3	EN	Enable Control Input.	
4		NC	No Internal Connection.	
5	1	VOUT	Output of the Regulator	
	Exposed	SGND	Substrate of Chip. Leave floating or tie to GND.	

Typical Application Circuits



Figure 1: Application circuit of Fixed $V_{\mbox{\scriptsize OUT}}$ LDO with enable function

Function Block Diagram



Absolute Maximum Ratings (Note 1)

VIN, EN to GND0.3V to 36V
VOUT to GND0.3V to 14V
VOUT to VIN
Package Thermal Resistance (Note 2)
SOT-23-5, θ _{JA} 200 °C /W
DFN-1x1-4L, θ _{JA} 195 °C /W
Lead Temperature (Soldering, 10 sec.) 260 °C
Junction Temperature 150 °C
Storage Temperature Range60 °C to 150 °C
ESD Susceptibility
HBM 2KV

Recommended Operating Conditions

Input Voltage VIN	2.0V to 30V
Junction Temperature Range	-40 °C to 125 °C
Ambient Temperature Range	-40 °C to 85 °C

Electrical Characteristics

(V_{IN} =15V, V_{EN} =5V, T_{A} =25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Supply Voltage	Vin		2		30	V
DC Output Voltage Accuracy		I _{LOAD} =0.1mA	-2		2	%
	Vdrop	V _{OUT} ≥ 5V		0.15		
Dropout Voltage (ILOAD =100mA)	Vdrop_3.3V	V _{OUT} = 3.3V		0.15		V
	Vdrop_1.8V	V _{OUT} = 1.8V		0.25		
Dropout Voltage (I _{LOAD} =200mA)	V _{DROP_1.8V}	V _{OUT} = 1.8V		0.47		V
	Ιq	V _{OUT} ≤ 5V		2.2		
Ground Current (ILOAD = 0mA)	I _{QH}	5V < V _{OUT} ≤ 12V		4.2		μA
Shutdown Ground Current	Isd	$V_{EN} = 0V,$ $V_{OUT} = 0V$		0.01	0.5	μA
	VIH	EN Rising			2	
Enable Threshold Voltage	VIL	EN Falling	0.6			V
EN Input Current	I _{EN}	V _{EN} = 30V		10	100	nA
Line Regulation	ΔLINE	$I_{LOAD} = 1mA,$ $5 \le V_{IN} \le 30V$		0.3		%
Load Regulation	ΔLOAD	$10mA \le I_{LOAD} \le 0.2A$		0.1		%
Output Current Limit	ILIM	V _{OUT} =0	201	400		mA
Power Supply Rejection Ratio	PSRR	$V_{OUT} = 5V,$ $I_{LOAD} = 1mA,$ $V_{IN} = 12V,$ f = 100Hz		70		dB
Thermal Shutdown Temperature	T _{SD}	I _{LOAD} =10mA		160		°C
Thermal Shutdown Hysteresis	ΔT_{SD}			15		°C

- **Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured at TA = 25°C on a DSTECH EVB board.

Typical Characteristics













DS8303



VOUT Turn on by VIN Quick Power Up













Application Guideline

Input and Output Capacitor Requirements

The external input and output capacitors of DS8303 series must be properly selected for stability and performance. Use a 1 μ F or larger input capacitor and place it close to the IC's VIN and GND pins. Any output capacitor meeting the minimum 1m Ω ESR (Equivalent Series Resistance) and effective capacitance between 1 μ F and 22 μ F requirement may be used. Place the output capacitor close to the IC's VOUT and GND pins. Increasing capacitance and decreasing ESR can improve the circuit's PSRR and line transient response.

Current Limit

The DS8303 series contain the current limiter of output power transistor, which monitors and controls the transistor, limiting the output current to 300mA (typical). The output can be shorted to ground indefinitely without damaging the part.

Dropout Voltage

The DS8303 series use a PMOS pass transistor to achieve low dropout. When (VIN – VOUT) is less than the dropout voltage (V_{DROP}), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the RDS_(ON) of the PMOS pass element. V_{DROP} scales approximately with the output current because the PMOS device behaves as a resistor in dropout condition.

As any linear regulator, PSRR and transient response are degraded as (VIN – VOUT) approaches dropout condition.

OTP (Over Temperature Protection)

The over temperature protection function of DS8303 series will turn off the P-MOSFET when the junction temperature exceeds 160°C (typ.). Once the junction temperature cools down by approximately 15°C, the regulator will automatically resume operation.

Thermal Application

For continuous operation, do not exceed the absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated as below:

T_A=25°C, DS-Tech PCB, The max PD (Max) = ($125^{\circ}C - 25^{\circ}C$) / ($200^{\circ}C/W$) = 0.5W for SOT-23-5 packages. The max PD (Max) = ($125^{\circ}C - 25^{\circ}C$) / ($195^{\circ}C/W$) = 0.51W for DFN-4L 1x1 package. Power dissipation (PD) is equal to the product of the output current and the voltage drop across the output pass element, as shown in the equation below:

 $PD = (VIN - VOUT) \times IOUT$

Layout Consideration

By placing input and output capacitors on the same side of the PCB as the LDO, and placing them as close as is practical to the package can achieve the best performance. The ground connections for input and output capacitors must be back to the DS8303 ground pin using as wide and as short of a copper trace as is practical. Connections using long trace lengths, narrow trace widths, and/or connections through via must be avoided. These

add parasitic inductances and resistance that results in worse performance especially during transient conditions.

Package Information:



Symbol	Millim	neters	Inches		
	Min.	Max.	Min.	Max.	
Α	0.889	1.295	0.035	0.051	
A1	0.000	0.152	0.000	0.006	
В	1.397	1.803	0.055	0.071	
b	0.250	0.560	0.010	0.022	
С	2.591	2.997	0.102	0.118	
D	2.692	3.099	0.106	0.122	
е	0.838	1.041	0.033	0.041	
Н	0.080	0.254	0.003	0.010	
L	0.300	0.610	0.012	0.024	

SOT-23-5L









DETAILA PIN #1 ID and Tie Bar Mark Options Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
Α	0.300	0.400	0.012	0.016
A1	0.000	0.050	0.000	0.002
A3	0.117	0.162	0.005	0.006
b	0.175	0.280	0.007	0.011
D	0.900	1.100	0.035	0.043
D2	0.430	0.550	0.017	0.022
E	0.900	1.100	0.035	0.043
E2	0.430	0.550	0.017	0.022
е	0.625		0.025	
L	0.200	0.300	0.008	0.012
Н	0.039		0.002	
H1	0.064		0.003	

DFN-1x1-4L